

2SK2800

Silicon N Channel MOS FET High Speed Power Switching

REJ03G1035-0900

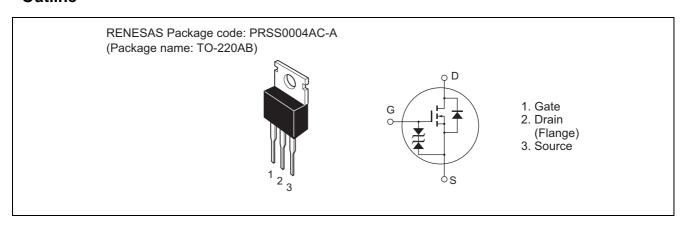
(Previous: ADE-208-513G)

Rev.9.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS(on)} = 15 \text{ m}\Omega \text{ typ.}$
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Ratings | Unit |
|--|-----------------------------|-------------|------|
| Drain to source voltage | V _{DSS} | 60 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | I _D | 40 | A |
| Drain peak current | I _{D(pulse)} Note1 | 160 | A |
| Body-drain diode reverse drain current | I _{DR} | 40 | A |
| Avalanche current | I _{AP} Note 3 | 40 | A |
| Avalanche energy | E _{AR} Note 3 | 137 | mJ |
| Channel dissipation | Pch Note 2 | 50 | W |
| Channel temperature | Tch | 150 | °C |
| Storage temperature | Tstg | −55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

3. Value at Tch = 25° C, Rg $\geq 50\Omega$

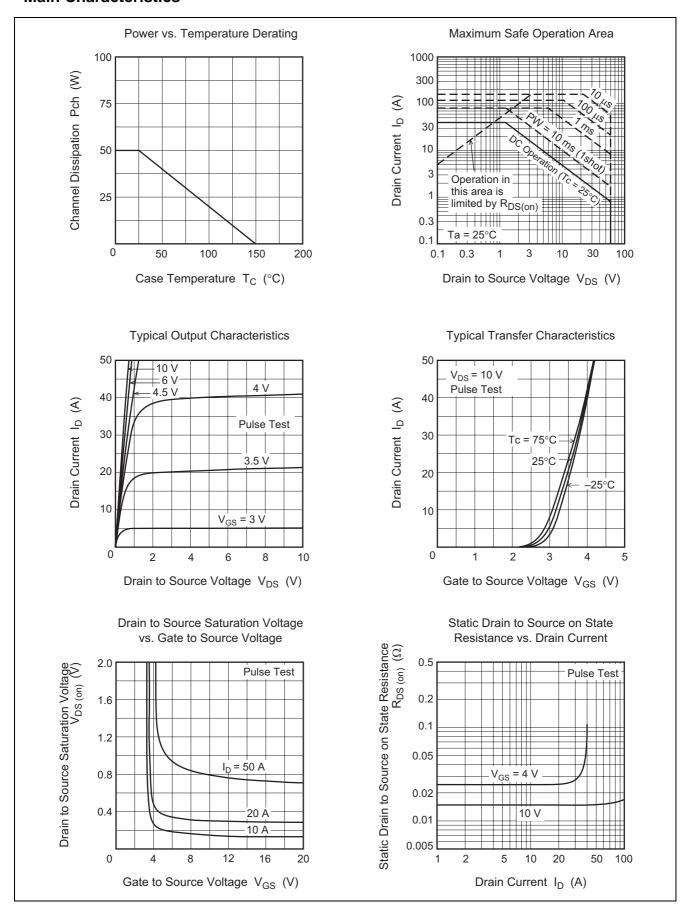
Electrical Characteristics

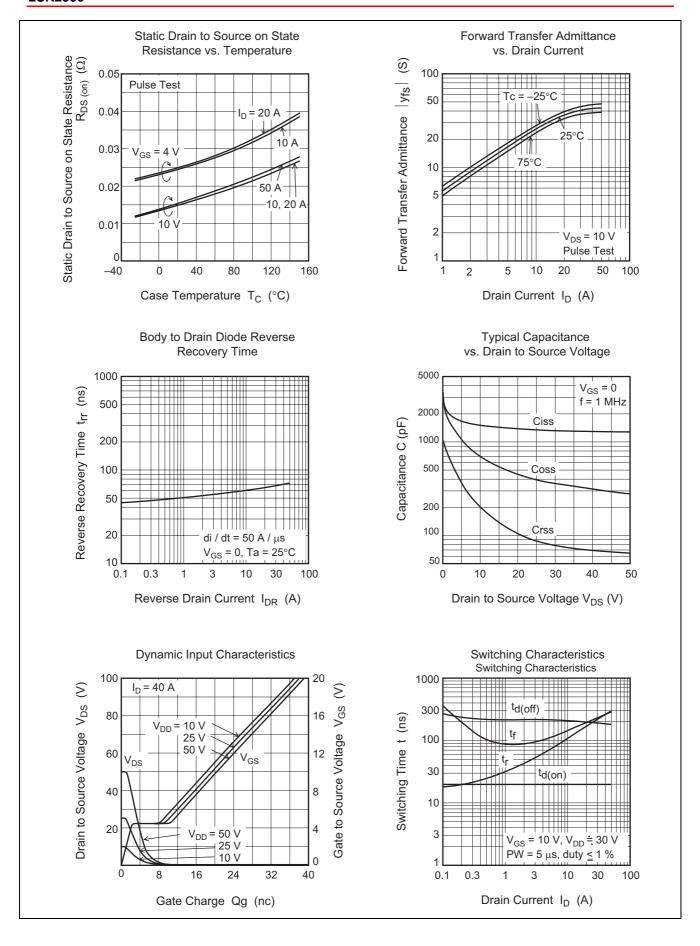
 $(Ta = 25^{\circ}C)$

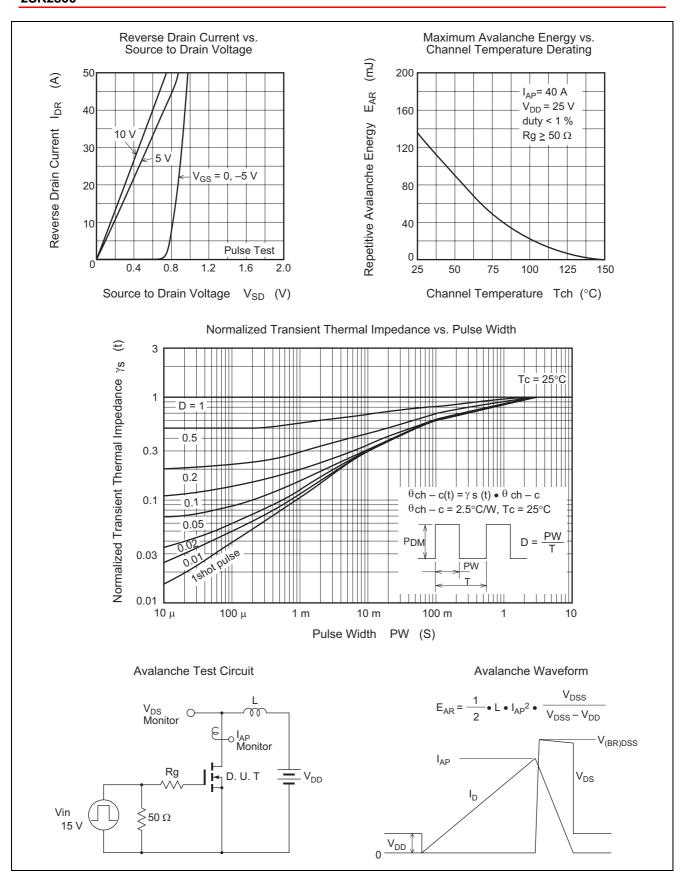
| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------------------------|---------------------|-----|------|-----|------|--|
| Drain to source breakdown voltage | $V_{(BR)DSS}$ | 60 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source breakdown voltage | $V_{(BR)GSS}$ | ±20 | _ | _ | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | I_{GSS} | | _ | ±10 | μΑ | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | | _ | 10 | μΑ | $V_{DS} = 60 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | $V_{GS(off)}$ | 1.5 | _ | 2.5 | V | $I_D = 1 \text{ mA}, V_{DS} = 10V$ |
| Static drain to source on state | R _{DS(on)} | _ | 15 | 20 | mΩ | $I_D = 20 \text{ A}, V_{GS} = 10 V^{\text{Note4}}$ |
| resistance | R _{DS(on)} | _ | 25 | 40 | mΩ | $I_D = 20 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note4}}$ |
| Forward transfer admittance | y _{fs} | 20 | 35 | _ | S | $I_D = 20 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$ |
| Input capacitance | Ciss | _ | 1500 | _ | pF | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$ |
| Output capacitance | Coss | _ | 720 | _ | pF | f = 1 MHz |
| Reverse transfer capacitance | Crss | _ | 200 | _ | pF | |
| Turn-on delay time | t _{d(on)} | _ | 20 | _ | ns | $I_D = 20 \text{ A}, R_L = 1.5 \Omega,$ |
| Rise time | t _r | _ | 180 | _ | ns | V _{GS} = 10 V |
| Turn-off delay time | t _{d(off)} | _ | 200 | _ | ns | |
| Fall time | t _f | _ | 200 | _ | ns | |
| Body-drain diode forward voltage | V_{DF} | _ | 0.95 | _ | V | $I_F = 40 \text{ A}, V_{GS} = 0$ |
| Body-drain diode reverse | t _{rr} | _ | 70 | _ | V | $I_F = 40 \text{ A}, V_{GS} = 0$ |
| recovery time | | | | | | di _F / dt =50 A/μs |

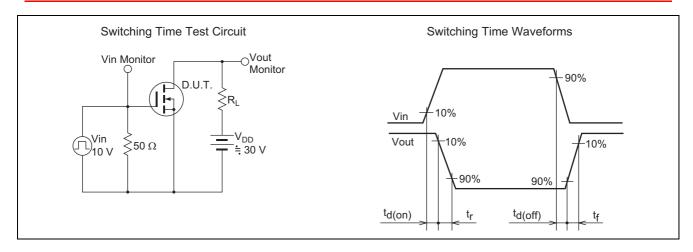
Note: 4. Pulse test

Main Characteristics

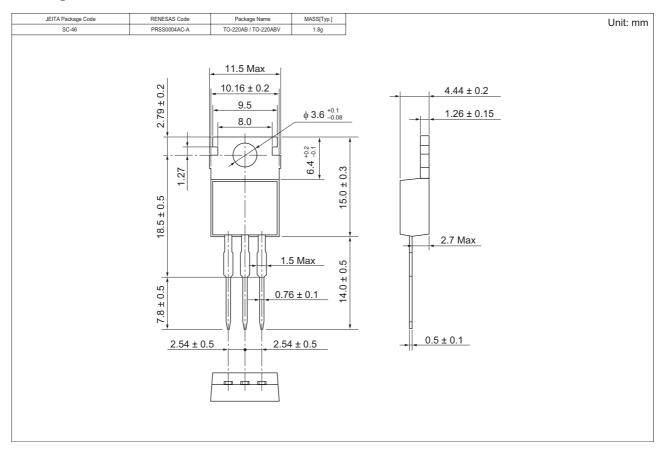








Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|-----------|----------|--------------------|
| 2SK2800-E | 500 pcs | Box (Sack) |

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